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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/645,800	08/22/2003	Jin Hyung Ryu	HI-0174 9284	
34610 KED & ASSO	7590 12/14/2007 DCIATES, LLP		EXAMINER	
P.O. Box 2212	200		DINH, DUC Q	
Chantilly, VA 20153-1200			ART UNIT	PAPER NUMBER
			2629	*
			MAIL DATE	DELIVERY MODE
			12/14/2007	PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

7		Application No.	Applicant(s)			
Office Action Summary		10/645,800	RYU ET AL.			
		Examiner	Art Unit			
		DUC Q. DINH	2629			
	The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply					
A SHO WHIC - Exter after - If NO - Failui Any r	ORTENED STATUTORY PERIOD FOR REPLY CHEVER IS LONGER, FROM THE MAILING DATE assions of time may be available under the provisions of 37 CFR 1.13 SIX (6) MONTHS from the mailing date of this communication. Period for reply is specified above, the maximum statutory period were to reply within the set or extended period for reply will, by statute, eply received by the Office later than three months after the mailing and patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be timused and will expire SIX (6) MONTHS from a cause the application to become ABANDONE	N. nely filed the mailing date of this communication. D (35 U.S.C. § 133).			
Status						
1)⊠	Responsive to communication(s) filed on <u>11 October 2007</u> .					
/	This action is FINAL . 2b)⊠ This action is non-final.					
3)□	- · · · · · · ·					
closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.						
Dispositi	on of Claims					
5)□ 6)⊠ 7)□	Claim(s) 1-7 and 13-22 is/are pending in the appearance of the above claim(s) is/are withdraw Claim(s) is/are allowed. Claim(s) 1-7 and 13-22 is/are rejected. Claim(s) is/are objected to. Claim(s) are subject to restriction and/o	wn from consideration.				
Applicati	on Papers					
10)	The specification is objected to by the Examine The drawing(s) filed on is/are: a) accomplicant may not request that any objection to the Replacement drawing sheet(s) including the correct The oath or declaration is objected to by the Example 1.	epted or b) objected to by the drawing(s) be held in abeyance. Setion is required if the drawing(s) is ob	e 37 CFR 1.85(a). jected to. See 37 CFR 1.121(d).			
Priority u	ınder 35 U.S.C. § 119					
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No. 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 						
Attachmen		лП., a	(DTO 440)			
2) Notice 3) Information	te of References Cited (PTO-892) te of Draftsperson's Patent Drawing Review (PTO-948) mation Disclosure Statement(s) (PTO/SB/08) or No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail D 5) Notice of Informal F 6) Other:	ate			

Art Unit: 2629

DETAILED ACTION

Continued Examination Under 37 CFR 1.114

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on 10/11/07 has been entered.

Claim Rejections - 35 USC § 112

- 2. The following is a quotation of the first paragraph of 35 U.S.C. 112:
 - The specification shall contain a written description of the invention, and of the manner and process of making and using it, in such full, clear, concise, and exact terms as to enable any person skilled in the art to which it pertains, or with which it is most nearly connected, to make and use the same and shall set forth the best mode contemplated by the inventor of carrying out his invention.
- 3. Claims 4-7 are rejected under 35 U.S.C. 112, first paragraph, as failing to comply with the written description requirement. The claim(s) contains subject matter which was not described in the specification in such a way as to reasonably convey to one skilled in the relevant art that the inventor(s), at the time the application was filed, had possession of the claimed invention. There is no support in the specification "wherein the multi-chip module is mounted on a printed circuit board (PCB) and input/output lines (connecting the at least one control chip and at least memory) are not formed directly on the PCB.

Art Unit: 2629

Claim Rejections - 35 USC § 103

4. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

- (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 5. Claims 1-7 and 13-20 are rejected under 35 U.S.C. 103(a) as being unpatentable over Applicant Admitted Prior Art, hereafter, AAPA, pages 1-8 in view of Kumar et al. (U.S Patent No. 5,876,536)

In reference to claim 1 the AAPA discloses in Figs. 3-4 a conventional (page 8, lines 5-6) driving apparatus of a plasma display panel (PDP), comprising a multi-chip module (32) in which at least one control chip having a control circuit (ASIC 26) for controlling the PDP, and at least one memory (RAM 33) are mounted on a single package (32), wherein the multi-chip module is mounted on a printed circuit board (PCB) of a control board (13) [Paragraph 0024] (the original specification discloses control board 13 is a conventional art at paragraph [0026]). The input/output lines coupling to the control chip and the memory (paragraph [0013]).

The AAPA does not disclose the multi-chip model includes a plurality of green tapes for mounting the control chip and the memory.

Kumar discloses circuit boards are made by casting glass and/or ceramic powders together with an organic powders into tapes, called green are used multilayer circuit board are well known. (col. 1, lines 14-26)

Therefore, it would have been obvious for one of ordinary skill in the art at the time of the invention to used the green tapes layers as the circuit board for the control chip and memory Art Unit: 2629

of the AAPA system as taught by Kumar because it could be used with lower melting, more conductive metals, such as silver, gold and copper (col. 1, lines 35-37)

In reference to claim 2, the AAPA discloses the package is a ball grid type [0022].

In reference to claim 3, the AAPA discloses the multiple chip module transmits a control signal to each driving unit via the PCB (Figs. 3-4; [0021-0022].

In reference to claim 13, the AAPA discloses a plasma display panel (PDP) driving apparatus comprising:

a control board having a circuit board (13) and a multi-chip module (32) on the circuit board, the multi-chip module including a plurality of control chips (26) and a plurality of memories (33) on a package, the control chip including a control circuit (ASIC) to control a PDP (the original specification discloses control board 13 is a conventional art at paragraph [0026]).

Wherein at least one of the control chip (ASIC) and at least one memory are formed on a front of the circuit package (see Fig. 4) and an input output lines are formed through the plurality of the circuit and the I/O lines connect the at least one control chip and the at least one memory [0024-0025]

The AAPA does not disclose the multiple chip module includes a circuit package having a plurality of circuit layers.

Kumar discloses circuit boards are made by casting glass and/or ceramic powders together with an organic powders into tapes, called green are used multilayer circuit board are well known. (col. 1, lines 14-26)

Application/Control Number: 10/645,800

Art Unit: 2629

Therefore, it would have been obvious for one of ordinary skill in the art at the time of the invention to used the green tapes layers as the circuit board for the control chip and memory of the AAPA system as taught by Kumar because it could be used with lower melting, more conductive metals, such as silver, gold and copper (col. 1, lines 35-37)

In reference to claim 14, refer to the rejection as applied to claim 2.

In reference to claim 15, refer to the rejection as applied to claim 3.

In reference to claim 16 the AAPA discloses a plurality of driving units to (18 at [0018]) generate and apply driving signals corresponding to control signals received from the control board (13).

In reference to claim 17, the AAPA discloses display (22) to display an image by a plasma discharge based on the driving signals applied from each of the plurality of driving units.

In reference to claim 18, the AAPA discloses wherein the control chip comprises an ASIC type (see claim 7).

In reference to claim 19, the AAPA discloses a plurality of control chips (26) mounted on the single package.

In reference to claims 20, the AAPA discloses a plurality of memories (33) mounted on the single package

6. Claims 4-7 and 21-22 are rejected under 35 U.S.C. 102(a) as being anticipated by Applicant Admitted Prior Art, hereafter, AAPA, pages 1-8 and Figs. 1-4.

In reference to claim 4, the AAPA discloses a driving apparatus of a plasma display panel, comprising:

a control board (13) provided with a multi-chip module (32) in which at least one control chip having a control circuit (26) for controlling the PDP, and at least one memory (33) are mounted on a single package (32) the original specification discloses control board 13 is a conventional art at paragraph [0026]).;

a plurality of driving units (18A-18B of Figs. 3-4) for generating and applying a driving signal corresponding to a control signal generated from the control board (13); and a PDP (Fig. 4) for displaying an image by a plasma discharge according to the driving signal applied from each of the plurality of driving units [0020-0025].

Wherein the multichip module is mounted on a printed circuit board (13) and input/output lines connecting the at least one control chip ([0023]) and the at least one memory is not formed directly on the PCB (13) [at least one of the memory is not mounted directly on the control board 13, but the timing control board (32) of the package as shown in Fig. 4 and paragraph [0015]).

In reference to claim 5, the AAPA discloses wherein the package is a ball grid type.

In reference to claim 6, the AAPA discloses the control board is provided with a printed circuit board (PCB) on which at least one package is mounted [0024].

In reference to claim 7, the AAPA discloses the control chip is an ASIC type having a control circuit (Figs, 3-4).

In reference to claim 21, the AAPA discloses a plurality of control chips (26) mounted on the single package.

In reference to claim 22, the AAPA discloses a plurality of memories (33) mounted on the single package.

Art Unit: 2629

Response to Arguments

7. Applicant's arguments filed on October 11, 2007, have been fully considered but they are not persuasive.

With respect to amended claim 1 and 13, see the new art rejection based on the AAPA and Kumar above.

With respect to claims 4-7, the AAPA shows the multi-chip module is mounted on a printed circuit board (13) and input/output lines connecting the at least one control chip (see paragraph [0024-25] and the at least one memory is not formed directly on the PCB (13) [at least one of the memory is not mounted directly on the control board 13, the memory is formed the timing control board (32) of the package as shown in Fig. 4 and paragraph [0015]).

Therefore, the rejection is maintained

Conclusion

8. Any inquiry concerning this communication or earlier communications from the examiner should be directed to DUC Q. DINH whose telephone number is (571) 272-7686. The examiner can normally be reached on Mon-Fri from 8:00.AM-4:00.PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Richard Hjerpe can be reached on (571) 272-7691. The fax phone number for the organization where this application or proceeding is assigned is **571-273-8300**.

Art Unit: 2629

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

DUC Q DINH

Primary Examiner

Art Unit 2629